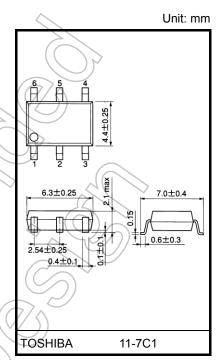
TOSHIBA Photocoupler Photorelay

TLP3120

High-Speed Memory Tester High-Speed Logic Tester High-Frequency Measurement Equipment

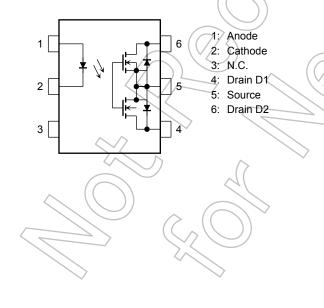
The Toshiba TLP3120 consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface mount assembly.

- 6-pin SOP (2.54SOP6): 2.1 mm high, 2.54 mm pitch
- Normally opened (form A) device
- Peak OFF-state voltage: 80 V (min)
- Trigger LED current: 5 mA (max)
- ON-state current: 1.25 A (max)
- ON-state resistance: 0.15Ω (max)
- Capacitance between output terminals: 1000 pF (max)
- Isolation voltage: 1500 V_{rms} (min)
- UL approved: UL1577, File No.E67349
- cUL approved :CSA Component Acceptance Service No. 5A, File No.E67349



Weight: 0.13 g (typ.)

Pin Configuration (top view)



Absolute Maximum Ratings (Ta = 25°C)

	Characteristics	Symbol	Rating	Unit
	Forward current	ΙF	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI _{F/} °C	-0.5	mA/°C
Led	Reverse voltage	V_{R}	5	V
Le	Diode power dissipation	P_D	50	mW
	Diode power dissipation derating (Ta ≥25°C)	ΔP_D /°C	-0.5	mW/°C
	Junction temperature	Tj	125	°C
	OFF-state output terminal voltage	V _{OFF}	80	\ <u>\</u>
	ON-state current	I _{ON}	1.25	A
Detector	ON-state current derating (Ta ≥ 25°C)	Δl _{ON/} °C	-12.5	mA/°C
Dete	Output power dissipation	Po	234	mW
	Output power dissipation derating (Ta ≥ 25°C)	ΔP _O /°C	-2.34	mW / °C
	Junction temperature	Tj	125	Ş. Ç
Storage temperature range		T _{stg}	-40 to 125	ç
Oper	Operating temperature range		-20 to 85	°C
Lead soldering temperature (10 s)		T _{sol}	260	°C (
Isolat	ion voltage (AC, 1 minute, R.H. ≤ 60%) (Note 1)	BVs	1500	Vrms

Note: Using continuously under heavy loads (e.g., the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device is considered as a two-terminal device. LED side pins are shorted together and detector side pins are shorted together.

Recommended Operating Conditions

			/ / / /		
Characteristics	Symbol	Min	Typ.	Max	Unit
Supply voltage	V _{DD}		\ \ !	64	V
Forward current	lF	5	1	30	mA
ON-state current	Ion		1	1.25	Α
Operating temperature	Topr	25	_	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward current	V _F	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μА
	Capacitance between terminals	C _T	V _F = 0 V, f = 1 MHz	_	15	_	pF
ctor	OFF-state current	l _{OFF}	V _{OFF} = 20 V, Ta = 50°C		1200	1500	рА
Detector	Capacitance between terminals	C _{OFF}	V = 0 V, f = 100 MHz	- 1	460	1000	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}	I _{ON} = 1.25 A	_	2	5	mA
Return LED current	I _{FC}	I _{OFF} = 10 μA	0.2	_	_	mA
ON-state resistance	R _{ON}	I _{ON} = 1.25 A, I _F = 5 mA	<i>\(\)</i>	0.11	0.15	Ω

Isolation Characteristics (Ta = 25°C)

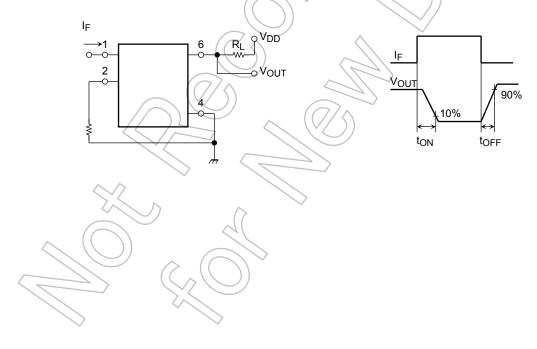
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Capacitance input to output	CS	V _S = 0 V, f = 1 MHz	<u></u>	0.8	-	pF	
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60%	5 × 10 ¹⁰	10 ¹⁴	-	Ω	
Isolation voltage		AC, 1 minute	1500	-	1	Vrmo	
	BV_S	AC, 1 second (in oil)	_	3000		Vrms	
		DC, 1 minute (in oil)	- /	3000	>-	Vdc	

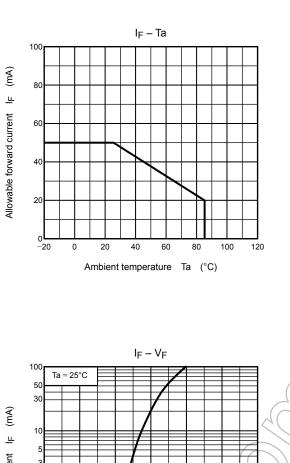
Switching Characteristics (Ta = 25°C)

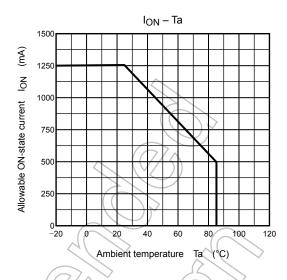
Characteristics	Symbol	Test Condition Min	Тур.	Max	Unit
Turn-ON time	ton	RL = 200 Ω	2.0	3.0	ms
Turn-OFF time	toff	V _{DD} = 20 V, I _F = 5 mA (Note 2)	0.7	1.0	1115

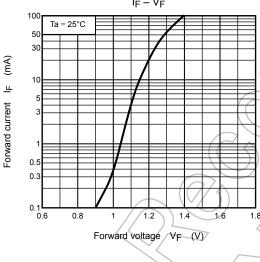
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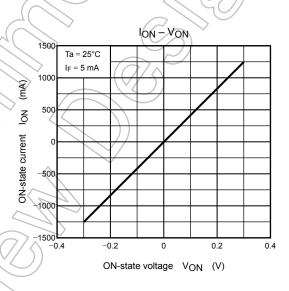
Note 2: Switching time test circuit

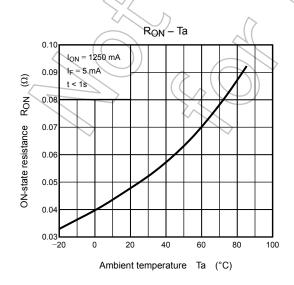


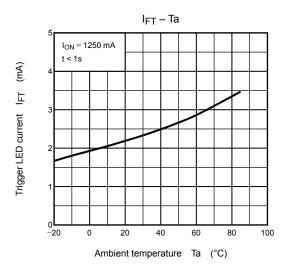




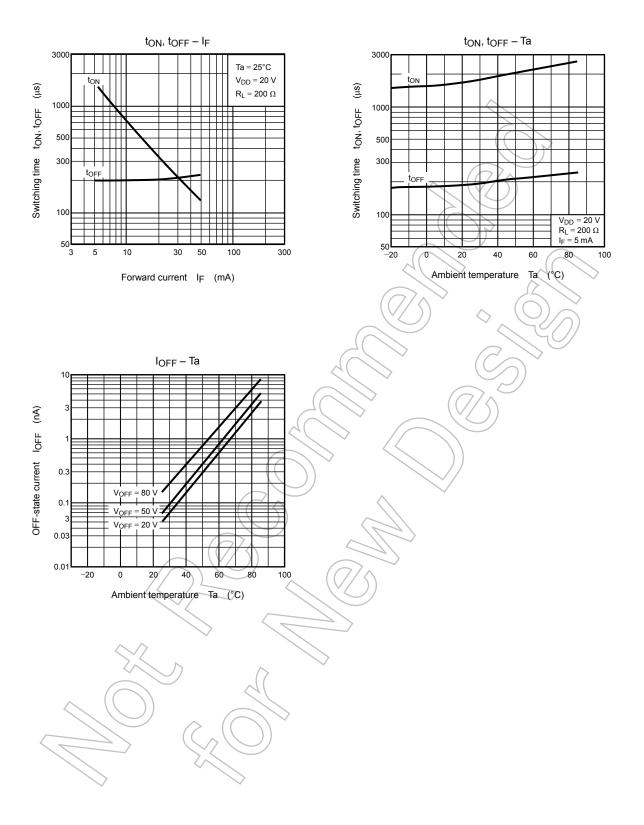








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